

## **E-MRS Spring Meeting 2019(フランス・ニース)熱電シンポジウムの お知らせ**

国際交流委員会委員長  
森 孝雄

熱電材料関連のシンポジウムが開催される E-MRS Spring Meeting 2019 のお知らせです。アジア開催 ICT に参加できない欧米の先生の参加が期待され、風光明媚な開催場所です。奮ってご参加下さい。

国際会議名 : E-MRS Spring Meeting 2019  
Symposium I

日時 : 2019 年 5 月 27 日～5 月 31 日

場所 : フランス・ニース

ホームページ :

(全体) <https://www.european-mrs.com/meetings/2019-spring-meeting>  
(熱電関連シンポジウム、Symposium I (Energy 領域の中))  
<https://www.european-mrs.com/recent-developments-thermoelectric-materials-and-applications-emrs>

アブストラクト〆切 : 1 月 15 日 2019 年

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TMS2018 EXHIBITION



TMS 2018  
147th Annual Meeting & Exhibition

#### MEETING NEWS

Request a Visa Invitation Letter  
Posted on: June 26, 2017



Many TMS2018 presenters will travel to Phoenix, Arizona, from other countries to attend TMS2018. Those presenters who require a travel visa to enter the United States are encouraged to [request a visa invitation letter](#) now and to begin the process of applying for a travel visa today.

## CALL FOR PAPERS

### Alloys and Compounds for Thermoelectric and Solar Cell Applications VI

2018 TMS Annual Meeting at Phoenix, Arizona  
March 11 - March 15, 2018

This symposium addresses synthesis, property measurements, phase stability, phase transformation of the alloys and compounds used in the thermoelectric and solar cell devices. Materials of interests include, but not limited to, skutterudites, superlattice, half-heusler alloys, CdTe, CIS, CIGS, CZTS and new materials for thermoelectric and solar cell applications. Abstracts are due by July 1<sup>st</sup>, 2017. Please submit abstracts directly to TMS Online. (<http://www.tms.org/tms2018>) (<http://www.programmaster.org/PM/PM.nsf/UpcomingSymposia/279949F4174B7190852580DD000131A2?OpenDocument&ParentUNID=5565C1172B38125085257DCD006DA70B>).

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